

<b>Order code</b>	<b>Manufacturer code</b>	<b>Description</b>
81-0488	n/a	2N7002 REEL 3K MOSFET SOT-23 (RC)
81-0490	n/a	2N7002 MOSFET SOT-23 (RC)

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The enclosed information is believed to be correct, Information may change 'without notice' due to product improvement. Users should ensure that the product is suitable for their use. E. & O. E.	Revision A 04/07/2003

## TECHNICAL SPECIFICATIONS OF N-CHANNEL SMALL SIGNAL MOSFET

### Description

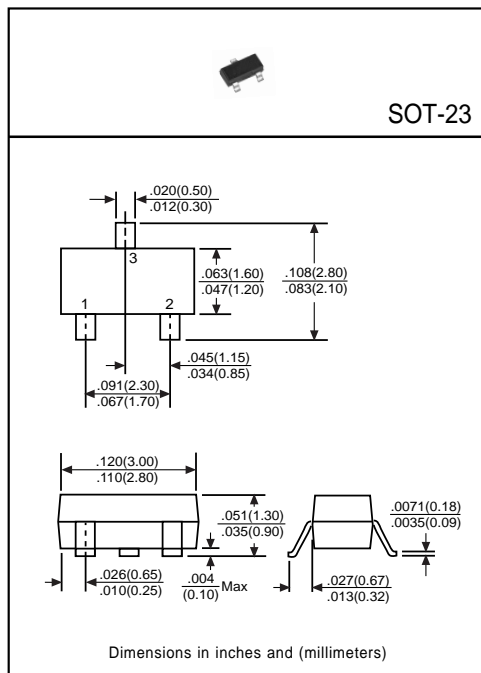
Designed for low voltage and low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

### Pinning

- 1 = Gate
- 2 = Source
- 3 = Drain

### Absolute Maximum Ratings<sub>(TA=25°C)</sub>

Characteristic	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	60	V
Drain-Gate Voltage (R <sub>GS</sub> =1MΩ)	V <sub>DGR</sub>	60	V
Gate-Source Voltage (Continuous)	V <sub>GS</sub>	±20	V
Drain Current (Continuous, T <sub>c</sub> =25°C) <sup>(1)</sup>	I <sub>D</sub>	115	mA
Drain Current (Pulsed) <sup>(2)</sup>	I <sub>DM</sub>	800	mA
Total Power Dissipation Derate above 25°C	P <sub>D</sub>	225 1.8	mW mW/°C
Operating Junction Temperature	T <sub>J</sub>	-55 to+150	°C
Storage Temperature	T <sub>STG</sub>	-55 to+150	°C
Maximum Lead Temperature, for 10 Seconds Soldering Purpose	T <sub>L</sub>	260	°C



### Electrical Characteristics

(Ratings at 25°C ambient temperature unless otherwise specified)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	60	-	-	V	I <sub>D</sub> =10μA, V <sub>GS</sub> =0
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-	-	1	μA	V <sub>DS</sub> =60V, V <sub>GS</sub> =0
Gate-Source Forward Leakage Current	I <sub>GSSF</sub>	-	-	100	nA	V <sub>GSF</sub> =20V, V <sub>DS</sub> =0
Gate-Source Reverse Leakage Current	I <sub>GSSR</sub>	-	-	-100	nA	V <sub>GSR</sub> =-20V, V <sub>DS</sub> =0
Gate Threshold Voltage <sup>(2)</sup>	V <sub>GS(th)</sub>	1	-	2.5	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =0.25mA
On-State Drain Current <sup>(2)</sup>	I <sub>D(on)</sub>	500	-	-	mA	V <sub>DS</sub> >2V <sub>DS(on)</sub> , V <sub>GS</sub> =10V
Static Drain-Source On-State Voltage <sup>(2)</sup>	V <sub>DS(on)1</sub>	-	-	1.5	V	I <sub>D</sub> =50mA, V <sub>GS</sub> =5V
	V <sub>DS(on)2</sub>	-	-	3.75	V	I <sub>D</sub> =500mA, V <sub>GS</sub> =10V
Static Drain-Source On-State Resistance <sup>(2)</sup>	R <sub>DS(on)1</sub>	-	-	7.5	Ω	I <sub>D</sub> =50mA, V <sub>GS</sub> =5V
	R <sub>DS(on)2</sub>	-	-	7.5	Ω	I <sub>D</sub> =500mA, V <sub>GS</sub> =10V
Forward Transconductance <sup>(2)</sup>	g <sub>FS</sub>	80	-	-	mS	V <sub>DS</sub> >2V <sub>DS(on)</sub> , I <sub>D</sub> =200mA
Input Capacitance	C <sub>iss</sub>	-	-	50	pF	V <sub>DS</sub> =25V, V <sub>GS</sub> =0, f=1MHz
Output Capacitance	C <sub>oss</sub>	-	-	25	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	-	-	5	pF	
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	-	-	417	°C/W	-

(1)The Power Dissipation of the package may result in a lower continuous drain current.

(2)Pulse Test: Pulse Width ≤300μs, Duty Cycle ≤2%